# onsemi

MARKING

### TinyLogic UHS Three-Input AND Gate

## NC7SZ11

#### Description

The NC7SZ11 is a single three-input AND Gate from **onsemi**'s Ultra-High Speed Series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive while maintaining low static power dissipation over a broad  $V_{CC}$  operating range. The device is specified to operate over the 1.65 V to 5.5 V  $V_{CC}$  operating range. The inputs and output are high impedance when  $V_{CC}$  is 0 V. Inputs tolerate voltages up to 5.5 V independent of  $V_{CC}$  operating voltage.

#### Features

- Ultra-High Speed:  $t_{PD} = 2.9$  ns (Typical) into 50 pF at 5 V V<sub>CC</sub>
- High Output Drive: ±24 mA at 3 V V<sub>CC</sub>
- Broad V<sub>CC</sub> Operating Range: 1.65 V to 5.5 V
- Power Down High Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra-Small MicroPak<sup>™</sup> Packages
- Space–Saving SC70 Package
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

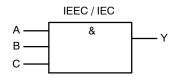
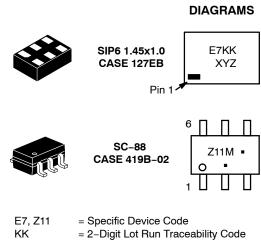


Figure 1. Logic Symbol



,	•
KK	= 2-Digit Lot Run Traceability Code
XY	= 2-Digit Date Code Format
Z	= Assembly Plant Code
М	= Date Code*
•	= Pb-Free Package

(Note: Microdot may be in either location) \*Date Code orientation and/or position may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet. NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 6.

#### **Pin Configurations**

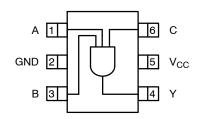
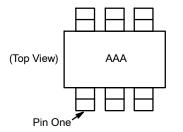


Figure 2. SC70 (Top View)



AAA represents Product Code Top Mark - see ordering code.

NOTE: Orientation of Top Mark determines Pin One location. Read the Top Product Code Mark left to right, Pin One is the lower left pin (see diagram).

#### Figure 3. Pin 1 Orientation

#### **PIN DEFINITIONS**

Pin # SC70	Pin # MicroPak	Name	Description
1	1	А	Input
2	2	GND	Ground
3	3	В	Input
4	4	Y	Output
5	5	V <sub>CC</sub>	Supply Voltage
6	6	С	Input

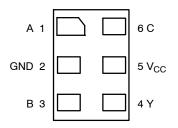


Figure 4. MicroPak (Top Through View)

FUNCTION T		( = ABC)
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	Inputs				
Α	В	С	Y		
Х	Х	L	L		
Х	L	Х	L		
L	Х	Х	L		
Н	Н	Н	Н		

H = HIGH Logic Level L = LOW Logic Level X = Either LOW or HIGH Logic Level



#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Paran	neter	Min	Мах	Unit
V <sub>CC</sub>	Supply Voltage		-0.5	6.5	V
V <sub>IN</sub>	DC Input Voltage		-0.5	6.5	V
V <sub>OUT</sub>	DC Output Voltage		-0.5	6.5	V
Ι <sub>ΙΚ</sub>	DC Input Diode Current	V <sub>IN</sub> < 0 V	-	-50	mA
Ι <sub>ΟΚ</sub>	DC Output Diode Current	V <sub>OUT</sub> < 0 V	-	-50	mA
I <sub>OUT</sub>	DC Output Current	•	-	±50	mA
$I_{CC} \text{ or } I_{GND}$	DC V <sub>CC</sub> or Ground Current		-	±50	mA
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature Under Bia	S	-	+150	°C
ΤL	Junction Lead Temperature (Solo	dering, 10 Seconds)	-	+260	°C
PD	Power Dissipation in Still Air	SC-88A	-	332	mW
		MicroPak-6	-	812	
ESD	Human Body Model, JESD22-A114		-	4000	V
	Charge Device Model, JESD22-	C101	-	2000	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Conditions	Min	Мах	Unit
V <sub>CC</sub>	Supply Voltage Operating		1.65	5.50	V
	Supply Voltage Data Retention		1.50	5.50	
V <sub>IN</sub>	Input Voltage		0	5.5	V
V <sub>OUT</sub>	Output Voltage		0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Times	$V_{CC}$ at 1.8 V, 2.5 V $\pm 0.2$ V	0	20	ns/V
		$V_{CC}$ at 3.3 V $\pm 0.3$ V	0	10	
		$V_{CC}$ at 5.0 V $\pm 0.5$ V	0	5	
$\theta_{JA}$	Thermal Resistance	SC-88A	-	377	°C/W
		MicroPak-6	-	154	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability. 1. Unused inputs must be held HIGH or LOW. They may not float.



### NC7SZ11

#### DC ELECTICAL CHARACTERISTICS

				T <sub>A</sub> = 25°C		T <sub>A</sub> = −40 to +85°C			
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
VIH	HIGH Level Input Voltage	1.65 to 1.95		0.65 V <sub>CC</sub>	-	-	0.65 V <sub>CC</sub>	-	V
		2.30 to 5.50		0.70 V <sub>CC</sub>	-	-	0.70 V <sub>CC</sub>	-	1
V <sub>IL</sub>	LOW Level Input Voltage	1.65 to 1.95		-	-	0.35 V <sub>CC</sub>	-	0.35 V <sub>CC</sub>	V
		2.30 to 5.50		-	-	0.30 V <sub>CC</sub>	-	0.30 V <sub>CC</sub>	1
V <sub>OH</sub>	HIGH Level Output Voltage	1.65	$V_{IN} = V_{IH} \text{ or } V_{IL},$	1.55	1.65	-	1.55	-	V
		2.30	I <sub>OH</sub> = −100 μA	2.20	2.30	-	2.20	-	1
		3.00		2.90	3.00	-	2.90	-	1
		4.50		4.40	4.50	-	4.40	-	1
		1.65	I <sub>OH</sub> = -4 mA	1.29	1.52	-	1.29	-	1
		2.30	I <sub>OH</sub> = -8 mA	1.90	2.15	-	1.90	-	
		3.00	I <sub>OH</sub> = -16 mA	2.50	2.80	-	2.40	-	1
		3.00	I <sub>OH</sub> = -24 mA	2.40	2.68	-	2.30	-	1
		4.50	I <sub>OH</sub> = -32 mA	3.90	4.20	-	3.80	-	1
V <sub>OL</sub>	LOW Level Output Voltage	1.65	$V_{IN} = V_{IH} \text{ or } V_{IL},$	-	0.00	0.10	-	0.10	V
		2.30	l <sub>OL</sub> = 100 μA	-	0.00	0.10	-	0.10	1
		3.00		-	0.00	0.10	-	0.10	1
		4.50		-	0.00	0.10	-	0.10	1
		1.65	I <sub>OL</sub> = 4 mA	-	0.80	0.24	-	0.24	1
		2.30	I <sub>OL</sub> = 8 mA	-	0.10	0.30	-	0.30	1
		3.00	I <sub>OL</sub> = 16 mA	-	0.15	0.40	-	0.40	1
		3.00	I <sub>OL</sub> = 24 mA	-	0.22	0.55	-	0.55	1
		4.50	I <sub>OL</sub> = 32 mA	-	0.22	0.55	-	0.55	1
I <sub>IN</sub>	Input Leakage Current	1.65 to 5.5	V <sub>IN</sub> = 5.5 V, GND	-	-	±1	-	±10	μA
I <sub>OFF</sub>	Power Off Leakage Current	0	$V_{IN}$ or $V_{OUT}$ = 5.5 V	-	-	1	-	10	μA
I <sub>CC</sub>	Quiescent Supply Current	1.65 to 5.50	V <sub>IN</sub> = 5.5 V, GND	-	-	2	-	20	μA

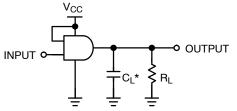


#### **AC ELECTRICAL CHARACTERISTICS**

					T <sub>A</sub> = 25°C		T <sub>A</sub> = -40	to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay	1.80 ±0.15	C <sub>L</sub> = 15 pF,	-	9.0	18.5	-	19.0	ns
	(Figure 5, 6)	2.50 ±0.20	$R_L = 1 M\Omega$	-	4.9	10.5	-	11.0	
		3.30 ±0.30		-	3.5	8.5	-	9.0	
		5.00 ±0.50		-	2.5	6.5	-	7.0	
		3.30 ±0.30	$C_{L} = 50 \text{ pF},$	-	4.1	8.5	-	9.0	
		5.00 ±0.50	$R_L = 500 \Omega$	-	2.9	7.5	-	8.0	
C <sub>IN</sub>	Input Capacitance	0.00		-	4	-	-	-	pF
	Power Dissipation Capacitance	3.30		-	20	-	-	_	pF
	(Note 2) (Figure 7)	5.00		-	25	-	-	-	

2. CPD is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. (See Figure 7) CPD is related to I<sub>CCD</sub> dynamic operating current by the expression:  $I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC} static).$ 

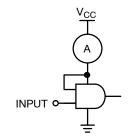
#### AC Loading and Waveforms



NOTES:

- 3. CL includes load and stray capacitance
- 4. Input PRR = 1.0 MHz,  $t_W = 500$  ns.

#### Figure 5. AC Test Circuit



#### t<sub>r</sub> = 3 ns $t_f = 3 \text{ ns}$ $V_{CC}$ 90% 90% 50% INPUT 50% 10% 10% GND tw PLH ▶tphl VOH 50% 50% OUTPUT VOL Figure 6. AC Waveforms

#### NOTE:

5. Input = AC Waveform;  $t_r = t_f = 1.8 \text{ ns}$ ; PRR = 10 MHz; Duty Cycle = 50%.

#### Figure 7. I<sub>CCD</sub> Test Circuit



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5
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#### NC7SZ11

#### **DEVICE ORDERING INFORMATION**

Device	Top Mark	Packages	Shipping <sup>†</sup>
NC7SZ11P6X	Z11	6-Lead SC70, EIAJ SC-88, 1.25 mm Wide	3000 / Tape & Reel
NC7SZ11L6X	E7	6-Lead MicroPak, 1.00 mm Wide	5000 / Tape & Reel

#### DISCONTINUED (Note 6)

NC7SZ11P6X-L22347	Z11	6-Lead SC70, EIAJ SC-88, 1.25 mm Wide	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

 DISCONTINUED: This device is not recommended for new design. Please contact your onsemi representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.

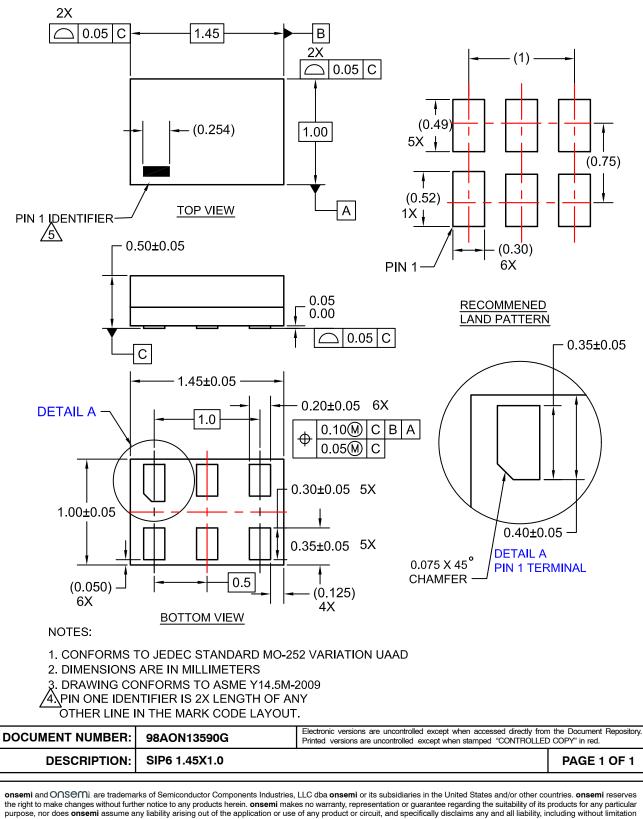
MicroPak is trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.





SIP6 1.45X1.0 CASE 127EB ISSUE O

DATE 31 AUG 2016

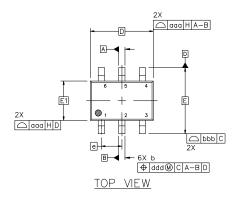


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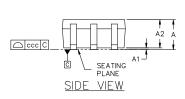
#### SC-88 2.00x1.25x0.90, 0.65P CASE 419B-02 **ISSUE Z**

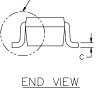
DATE 18 APR 2024



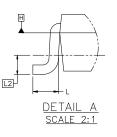


- DIMENSIONING AND TOLERANCING CONFORM TO ASME 1. Y14.5-2018.
- 2.
- ALL DIMENSION ARE IN MILLIMETERS. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 3. PER END.
- 4. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF
- DATUMS A AND B ARE DETERMINED AT DATUM H. 5.
- DIMENSIONS & AND C APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP. 6.
- DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. 7 ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION & AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.





DETAIL A



	MILLIMETERS				
DIM	MIN.	NOM.	MAX.		
A			1.10		
A1	0.00		0.10		
A2	0.70	0.90	1.00		
b	0.15	0.20	0.25		
С	0.08	0.15	0.22		
D		2.00 BSC	;		
E	2.10 BSC				
E1		1.25 BSC	;		
е		0.65 BSC	)		
L	0.26	0.36	0.46		
L2		0.15 BSC			
aaa	0.15				
bbb	0.30				
ссс		0.10			
ddd		0.10			

6X 0.66 6X 0.30-2.50 0.65 PITCH

RECOMMENDED MOUNTING FOOTPRINT\*

FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

XXX = Specific Device Code = Date Code\* Μ

GENERIC **MARKING DIAGRAM\*** 

XXXM-

. 0

6

= Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

#### **STYLES ON PAGE 2**

DOCUMENT NUMBER:	98ASB42985B	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.				
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#### SC-88 2.00x1.25x0.90, 0.65P CASE 419B-02 ISSUE Z

#### DATE 18 APR 2024

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13:	STYLE 14:	STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:
PIN 1. ANODE	PIN 1. VREF	PIN 1. ANODE 1	PIN 1. BASE 1	PIN 1. BASE 1	PIN 1. VIN1
2. N/C	2. GND	2. ANODE 2	2. EMITTER 2	2. EMITTER 1	2. VCC
3. COLLECTOR	3. GND	3. ANODE 3	3. COLLECTOR 2	3. COLLECTOR 2	3. VOUT2
4. EMITTER	4. IOUT	4. CATHODE 3	4. BASE 2	4. BASE 2	4. VIN2
5. BASE	5. VEN	5. CATHODE 2	5. EMITTER 1	5. EMITTER 2	5. GND
6. CATHODE	6. VCC	6. CATHODE 1	6. COLLECTOR 1	6. COLLECTOR 1	6. VOUT1
STYLE 19:	STYLE 20:	STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:
PIN 1. I OUT	PIN 1. COLLECTOR	PIN 1. ANODE 1	PIN 1. D1 (i)	PIN 1. Vn	PIN 1. CATHODE
2. GND	2. COLLECTOR	2. N/C	2. GND	2. CH1	2. ANODE
3. GND	3. BASE	3. ANODE 2	3. D2 (i)	3. Vp	3. CATHODE
4. V CC	4. EMITTER	4. CATHODE 2	4. D2 (c)	4. N/C	4. CATHODE
5. V EN	5. COLLECTOR	5. N/C	5. VBUS	5. CH2	5. CATHODE
6. V REF	6. COLLECTOR	6. CATHODE 1	6. D1 (c)	6. N/C	6. CATHODE
STYLE 25:	STYLE 26:	STYLE 27:	STYLE 28:	STYLE 29:	STYLE 30:
PIN 1. BASE 1	PIN 1. SOURCE 1	PIN 1. BASE 2	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. SOURCE 1
2. CATHODE	2. GATE 1	2. BASE 1	2. DRAIN	2. ANODE	2. DRAIN 2
3. COLLECTOR 2	3. DRAIN 2	3. COLLECTOR 1	3. GATE	3. COLLECTOR	3. DRAIN 2
4. BASE 2	4. SOURCE 2	4. EMITTER 1	4. SOURCE	4. EMITTER	4. SOURCE 2
5. EMITTER	5. GATE 2	5. EMITTER 2	5. DRAIN	5. BASE/ANODE	5. GATE 1
6. COLLECTOR 1	6. DRAIN 1	6. COLLECTOR 2	6. DRAIN	6. CATHODE	6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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